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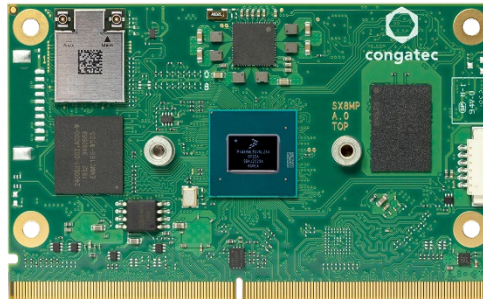
DISTEC

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Manual

congatec

conga-SMX8-Plus

SMARC 2.1 module based on NXP i.MX 8M Plus 14nm processor series with ARM 4-Core Cortex-A53 / M7 + NPU

conga-SMX8-Plus

Sample Distribution Set for congatec SMARC 2.1 Development

Quick Start Guide

Revision 1.0

Preface

This quick start guide provides information about the contents of the conga-SMX8-Plus sample distribution set and how to set it up.

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Revision History

Revision	Date (yyyy-mm-dd)	Author	Changes
1.0	2021-06-30	BEU	First release

1   Hardware

1.1   Sample Distribution Set

The following items are included in the sample distribution set:

Part #	Rev.	Name	Description	Qty
051320/ 051321/ 051322	X.1	conga-SMX8-Plus	SMARC 2.1 module engineering sample with NXP i.MX 8M Plus Quad processor. Module variant depending on sample availability and customer request.	1
051350/ 051351	X.0	CSP-B/ HSP-B	Passive cooling solution or heatspreader depending on customer request. All standoffs are with 2.7 mm bore hole.	1
007010	C.1	conga-SEVAL	Evaluation carrier board for SMARC modules.	1
48000023	A	RS-232 adapter cable	MOLEX 6-Pin PicoBlade to two D-SUB 9	1
10000116	A	RS-232 to USB adapter	USB 2.0 to standard serial port. Based on FTDI-Chipset.	1
10000413	A	SD card	SANDISK Ultra 16 GB Class 10 UHS-1	1
011115	B.0	conga-LDVI/EPI	LVDS to DVI converter board for digital flat panels with onboard EEPROM.	1
033331	A	cab-LVDV-DAT-34-15	15 cm data cable LVDS to DVI adapter	1
052147	A	cab-LVDV-PWR-10-15	15 cm power cable LVDS to DVI adapter	1
N/A	1.0	Quick Start Guide	conga-SMX8-Plus Sample Distribution Set Quick Start Guide	1

1.2   conga-SMX8-Plus

The included conga-SMX8-Plus engineering sample module variant depends on sample availability and customer request. The key features and differences of the variants are summarized in the table below:

Part #	051320	051321	051322
Processor	NXP i.MX 8M Plus Quad	NXP i.MX 8M Plus Quad	NXP i.MX 8M Plus Quad
LPDDR4	4 GB	2 GB	4 GB
eMMC	16 GB	16 GB	16 GB
Temp. Range	Industrial (-40°C to 85°C)	Industrial (-40°C to 85°C)	Extended (-25°C to 85°C)
WiFi/BT	No	No	Yes (AW-CM276NF)

For more information about the conga-SMX8-Plus Mass Production (MP) module variants, refer to the datasheet available at www.congatec.com

1.2.1   Pinout Description

The pinout description lists which signals of the NXP i.MX 8M Plus Quad processor are routed to the SMARC connector.

Use the link below to directly download the conga-SMX8-Plus pinout as an Excel file:

https://git.congatec.com/arm-nxp/imx8-family/doc/cgtimx8_pinlist/-/raw/cgtsx8p_pinlist/cgtsx8p_pin_connection.xlsx

Alternatively, use the link below and follow the instructions to download it:

https://git.congatec.com/arm-nxp/imx8-family/doc/cgtimx8_pinlist

1.3   conga-SEVAL

The conga-SEVAL (Revision C.1) included in this sample distribution set is an evaluation carrier board based on the SMARC Specification.

For information about the conga-SEVAL, refer to the User's Guide available at www.congatec.com

1.4   Hardware Setup

Follow the steps below to set up the hardware:

1. Ensure the hardware is protected from the effects of electrostatic discharge (ESD).

2. On the carrier board, set DIP switch M12 #1 to OFF (Audio: I²S)

3. On the carrier board, set M17 #1 and #2 to ON and M18 #1 to OFF (Boot from USDHC2 SD/SDIO).[1]

4. Connect the RS-232 adapter cable to the connector on the module.

5. Connect the USB 2.0 to Serial Adapter to the RS-232 adapter cable port labeled "CONSOLE".

6. Mount the cooling solution onto the module. (Final torque: 0.4 Nm)

7. Mount the module onto the carrier board. (Final torque: 0.4 Nm)

8. Optionally, connect the conga-LDVI/EPI as shown in the picture.[2]

9. Insert the SD card into the SD card slot of the carrier board.[3]

10. Connect an ATX Power Supply Unit (PSU) to the carrier board.

11. To start the system, switch the ATX PSU on.[4]

Note

1. To select a different boot source, see the DIP switch settings below:

| M17 | | M18 | Selected |
#1	#2	#1	Boot Source
ON	ON	OFF	SD card
OFF	ON	OFF	eMMC
OFF	ON	ON	SPI Flash

2. HDMI is the default video output. LVDS output currently requires device tree updates and recompilation.

3. Refer to section 2.1 "Building the Image" to build the image first.

4. To enable serial downloader mode, set jumper X45 to position 2-3.
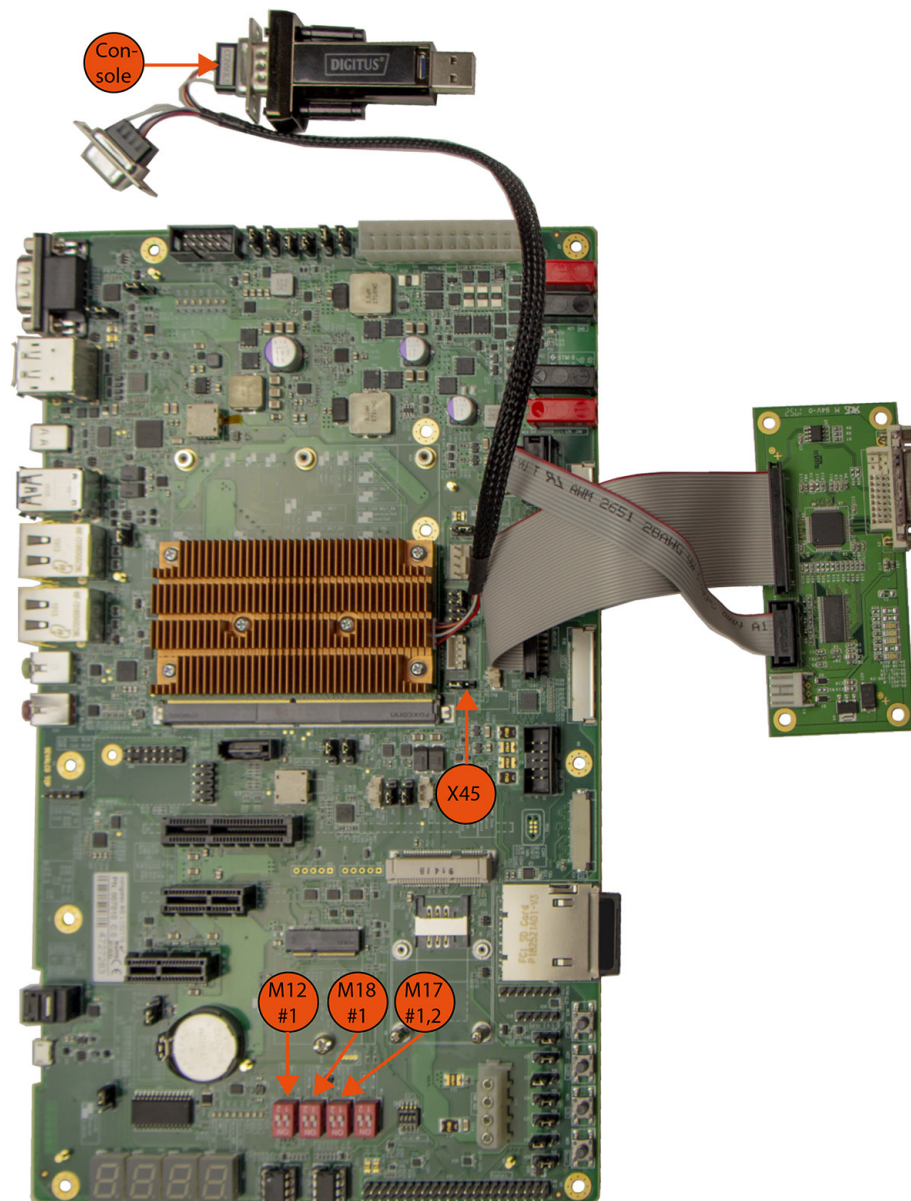
2   Software

2.1   Building the Image

To build the Linux operating system image for the conga-SMX8-Plus, follow the instructions described in the website below:

https://wiki.congatec.com

> ✏️ **Note**
>
> *Contact congatec technical support to get access to the repositories.*
>
> *Install the image on the included SD card or another SANDISK Ultra 16 GB Class 10 UHS-1. Other SD cards may not work with the conga-SEVAL.*

2.2   Starting Up

The conga-SMX8-Plus uses U-Boot as standard bootloader. The bootloader is GNU GPL open source software. A serial terminal connection is required in order to display the boot process and to modify the boot behavior. The boot behavior is controlled via environment variables.

The included RS-232 adapter cable has two connectors. The RX/TX signals are already crossed. Therefore, do NOT use a crossover-cable. Use the connector labeled "CONSOLE" for the U-Boot console output.

To establish a terminal connection, a terminal program such as TeraTerm or Putty can be used.

Use the following communication parameters:

Baud rate:	115200
Data:	8 bit
Parity:	none
Stop:	1 bit
Flow control:	none

2.3   Boot Process

The conga-SMX8-Plus boot process starts at Power On Reset (POR), where the hardware reset logic forces the ARM core to begin execution. The on-chip boot ROM loads the bootloader.

After loading, the bootloader is executed and performs basic system initialization (serial console, etc.). Afterwards, the environment settings are parsed and the system boot continues as specified.

Press any key during startup to stop autoboot and to get to U-Boot console. At the U-Boot console, the environment settings can be displayed using the "print" command. In addition, useful functionality is available (such as memory dump, access to the SPI and the I2C system, etc.). The "help" command will display any command supported by the U-Boot.

If autoboot is not interrupted by pressing a key, the boot process goes ahead and the module boots the Linux operating system installed on the SD card.

2.4   U-Boot Environment Variables

The pre-compiled binaries from congatec support SD card and onboard eMMC boot source. One of the benefits of the U-Boot bootloader is the possibility to specify its run time configuration using environment variables.

The environment variables of U-Boot can be displayed using the printenv (or the print) command.

During the boot process, the bootloader evaluates the "bootcmd" variable and executes it. The boot command tries to load a bootscript or a kernel from the boot device. If this is successful, the script or kernel will be started, otherwise a fallback to network boot is performed. The variable "mmcdev" specifies the mmc boot device. Furthermore, the variable "mmcroot" is passed to the kernel in order to specify the location of the root filesystem.

The following environment variables are predefined for conga-SMX8-Plus:

Name	Default value	Description
bootcmd		Defines the startup command of the bootloader, i.e. how the system performs the boot process.
fdt_file	"imx8mp-cgtsx8p.dtb"	The device tree blob, might be exchanged in order to enhance functionality.
image	Image	The name of the kernel image file that is loaded during boot process.
ipaddr	not specified	Address of the system (used for network boot).
serverip	not specified	Address of the remote host (used for network boot).
netmask	not specified	Netmask of the network (used for network boot).
nfsroot	not specified	The location where the NFS root filesystem is stored (used for network boot).
mmcdev	not specified (autodetect)	The boot device number (used for mmcboot). Default: Automatially set to match the device that u-boot was loaded from (see mmcautodetect).
mmcpart	"1" (first partition)	The number of the bootpartiton on the bootdevice (used for mmcboot).
mmcroot	not specified (autodetect)	The root filesystem (used for mmcboot), might also be used to extend the kernel command line. Default: Automatially set to match the device that u-boot was loaded from (see mmcautodetect).
mmcautodetect	"yes"	Set to "no" in order to manually set mmcdev and mmcroot

Following, some frequently used scripts:

Name	Description
mmcboot	Boots the system from mmc (with the specified parameters for mmcboot), i.e. eMMC, SD card
mmcargs	Configures the bootargs for mmcboot
netboot	Boots the system from network (with the specified parameters for network boot)
netargs	Configures the bootargs for network boot
loadbootscript	Used during boot, loads an eventually existing boot script
loadimage	Used during boot, loads the kernel
loadfdt	Used during boot, loads the device tree blob file

There are several commands to change the behavior of the bootloader and to customize the boot process. The help command can be used to display a list of all available commands.

2.5 Linux

By default, the system boots the Linux operating system that is stored on the SD card. Booting to the Linux desktop may take some time. To speed up the boot process significantly, install the root filesystem onto the onboard eMMC device. In case of questions, contact congatec technical support.

Note

In order to maintain the integrity of the file system, it is recommended to always shut down the system by issuing the command "poweroff" in the console terminal.

2.6 Additional Information

The NXP i.MX 8M Plus Quad processor documentation is available at: www.nxp.com

FORTEC
ELEKTRONIK AG

Our company network supports you worldwide with offices in Germany, Austria, Switzerland, the UK and the USA. For more information please contact:

Headquarters

Germany

FORTEC
ELEKTRONIK AG

FORTEC Elektronik AG	Phone:	+49 89 894450-0
Augsburger Str. 2b	E-Mail:	info@fortecag.de
82110 Germering	Internet:	www.fortecag.de

Fortec Group Members

Austria

DISTEC
A FORTEC GROUP MEMBER

Distec GmbH,	Phone:	+43 1 8673492-0
Office Vienna	E-Mail:	info@distec.de
	Internet:	www.distec.de
Nuschinggasse 12		
1230 Wien		

Germany

DISTEC
A FORTEC GROUP MEMBER

Distec GmbH	Phone:	+49 89 894363-0
Augsburger Str. 2b	E-Mail:	info@distec.de
82110 Germering	Internet:	www.distec.de

Switzerland

ALTRAC
A FORTEC GROUP MEMBER

ALTRAC AG	Phone:	+41 44 7446111
Bahnhofstraße 3	E-Mail:	info@altrac.ch
5436 Würenlos	Internet:	www.altrac.ch

United Kingdom

DISPLAY
TECHNOLOGY
A FORTEC GROUP MEMBER

Display Technology Ltd.	Phone:	+44 1480 411600
Osprey House, 1 Osprey Court	E-Mail:	info@displaytechnology.co.uk
Hinchingbrooke Business Park	Internet:	www. displaytechnology.co.uk
Huntingdon, Cambridgeshire, PE29 6FN		

USA

APOLLO DISPLAY
TECHNOLOGIES
A FORTEC GROUP MEMBER

Apollo Display Technologies, Corp.	Phone:	+1 631 5804360
87 Raynor Avenue,	E-Mail:	info@apollodisplays.com
Unit 1Ronkonkoma,	Internet:	www.apollodisplays.com
NY 11779		